



NOTES:
 1. MATERIAL:
 HOUSING:LCP, BLACK, UL 94V-0
 CONTACT:PHOSPHORBRONZE, T=0.15MM
 SHELL:STAINLESS STEEL T=0.20MM
 2. GP PASSED ACCORD WITH HRD-RoHS-219 STANDARD.
 3. FINISH
 CONTACT: 50U'' MIN PLATING OVER ALL
 3U'' AU ON THE CONTACT AREA
 GOLD FLASH ON THE SOLDER AREA
 SHELL:SELECTIVE GOLD FLASH IN SOLDER TAIL AREA
 50U'' NI MIN. PLATING OVER ALL
 4. ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
 ALL DIMENSIONS MARKER (XX) MUST BE MEASURE BY FAI.

| T-CARD PIN NO. | PIN NO. |
|------------------|---------|
| P1 | DAT2 |
| P2 | CD/DAT3 |
| P3 | CMD |
| P4 | VDD |
| P5 | CLK |
| P6 | VSS |
| P7 | DATO |
| P8 | DAT1 |
| SIM CARD PIN NO. | PIN NO. |
| P1-A/B | VCC |
| P2-A/B | RST |
| P3-A/B | CLK |
| P5-A/B | GND |
| P6-A/B | VPP |
| P7-A/B | I/O |

| REV. | ECN NO. | DESCRIPTION | DATE | UNITS: mm | GENERAL TOLERANCE | DRAW: | PART NO: |
|------|---------|-------------|------------|---------------------|---|--|--|
| | | | | | X. ±0.15 X' ±2.00 | | S29-2B20A33A |
| | | | | DATE: 09/07/2016 | X ±0.10 X' ±1.00 | CHECKED: | TITLE: MICRO SIM CARD+SIM CARD+ T-CARD H=3.35mm 防浪pin结构 |
| | | | | SCALE: 3:1 | .XX ±0.05 .XXX ±0.02 .XXX' ±0.10' | APPROVE: | DRAWING NO: |
| A | | NEW | 09/07/2016 | SHEET: 1/1 | MATERIAL: | 昆山捷皇电子精密科技有限公司 HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD. | |
| | | | | REV. A | FINISH: SEE NOTE | | |